imall

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1.5V Drive Pch MOSFET **RZQ045P01**

Structure

Silicon P-channel MOSFET

Features

- 1) Low on-resistance.
- 2) High power package.
- 3) Low voltage drive. (1.5V)

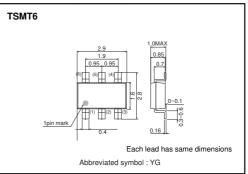
Applications

Switching

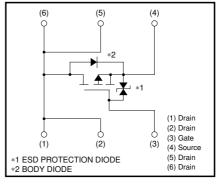
Packaging specifications

	Package	Taping					
Туре	Code	TR					
	Basic ordering unit (pieces)	3000					
RZQ045P0	0						

•Dimensions (Unit : mm)



Equivalent circuit



•Absolute maximum ratings (Ta=25°C)

Parameter		Symbol		Limits	Unit	
Drain-source voltage		V _{DSS}		-12	V	
Gate-source voltage		V _{GSS}		±10	V	
Drain current	Continuous	ID		±4.5	А	
	Pulsed	I DP	*1	±12	А	
Source current	Continuous	ls		-1	А	
(Body diode)	Pulsed	ISP	*1	-12	А	
Total power dissipation		PD	*2	1.25	W	
Channel temperature		Tch		150	°C	
Range of Storage temperature		Tstg		-55 to +150	°C	

*1 Pw≤10µs, Duty cycle≤1% *2 Mounted on a ceramic board

Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a) *	100	°C / W
* Mounted on a ceramic board			

Mounted on a ceramic board.



Transistors

•Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	±10	μA	V _{GS} =±10V, V _{DS} =0V
Drain-source breakdown voltage	V(BR) DSS	-12	-	-	V	$I_D = -1mA$, $V_{GS} = 0V$
Zero gate voltage drain current	IDSS	-	-	-1	μΑ	$V_{DS}=-12V, V_{GS}=0V$
Gate threshold voltage	VGS (th)	-0.3	-	-1.0	V	$V_{DS} = -6V$, $I_{D} = -1mA$
Static drain-source on-state resistance	R _{DS} (on)	-	25	35	mΩ	$I_D = -4.5A$, $V_{GS} = -4.5V$
		-	31	43	mΩ	$I_D = -2.2A, V_{GS} = -2.5V$
		_	39	58	mΩ	$I_D = -2.2A, V_{GS} = -1.8V$
		-	50	100	mΩ	ID= -0.9A, VGS= -1.5V
Forward transfer admittance	Y _{fs} *	6.5	-	-	S	$V_{DS} = -6V, I_{D} = -4.5A$
Input capacitance	Ciss	-	2450	-	pF	V _{DS} = -6V
Output capacitance	Coss	-	320	—	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	290	_	pF	f=1MHz
Turn-on delay time	td (on) *	-	12	_	ns	ID= -2.2A
Rise time	tr *	-	75	-	ns	VDD≒ –6V VGS= –4.5V
Turn-off delay time	td (off) *	_	390	_	ns	$R_{L} = 2.7\Omega$
Fall time	t _f *	-	215	-	ns	R _G =10Ω
Total gate charge	Qg *	-	31	_	nC	VDD≒-6V RL≒1.3Ω
Gate-source charge	Q _{gs} *	-	4.5	-	nC	$V_{GS} = -4.5V$ R _G =10 Ω
Gate-drain charge	Q _{gd} *	_	4.0	-	nC	I _D =-4.5A

*Pulsed

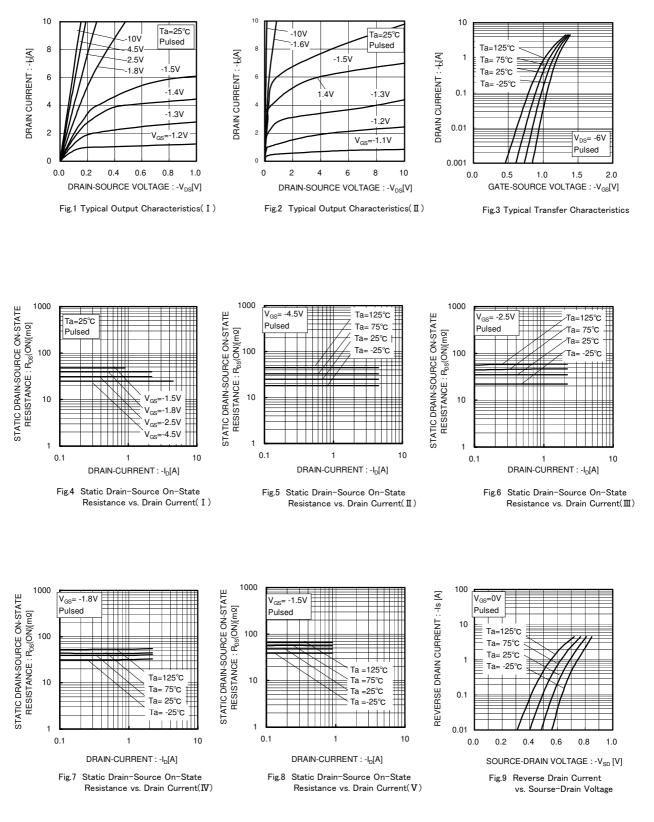
•Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsd *	_	-	-1.2	V	Is= -4.5A, Vgs=0V
*Pulsod						

*Pulsed

Transistors

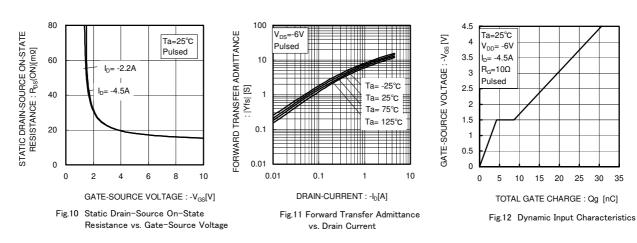
•Electrical characteristic curves

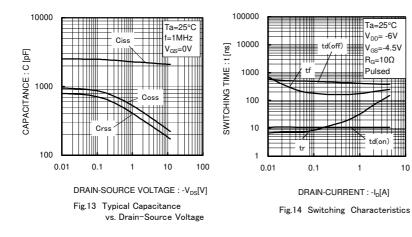


ROHM

RZQ045P01

Transistors





Transistors

Measurement circuits

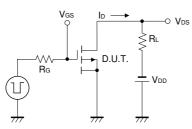


Fig.15 Switching Time Measurement Circuit

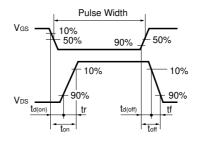


Fig.16 Switching Waveforms

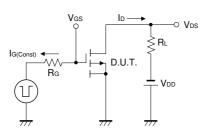


Fig.17 Gate Charge Measurement Circuit

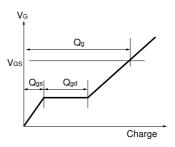


Fig.18 Gate Charge Waveform

Notice

This product might cause chip aging and breakdown under the large electrified environment . Please consider to design ESD protection circuit.

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